# HEF4094B-Q100

## 8-stage shift-and-store register

Rev. 5 — 8 July 2021

**Product data sheet** 

### 1. General description

The HEF4094B-Q100 is an 8-bit serial-in/serial or parallel-out shift register with a storage register and 3-state outputs. Both the shift and storage register have separate clocks. The device features a serial input (D) and two serial outputs (QS1 and QS2) to enable cascading. Data is shifted on the LOW-to-HIGH transitions of the CP input. Data is available at QS1 on the LOW-to-HIGH transitions of the CP input to allow cascading when clock edges are fast. The same data is available at QS2 on the next HIGH-to-LOW transition of the CP input to allow cascading when clock edges are slow. The data in the shift register is transferred to the storage register when the STR input is HIGH. Data in the storage register appears at the outputs whenever the output enable input (OE) is HIGH. A LOW on OE causes the outputs to assume a high-impedance OFF-state. Operation of the OE input does not affect the state of the registers. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of VDD.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

### 2. Features and benefits

- · Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - Specified from -40 °C to +85 °C and -40 °C to +125 °C
- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Wide supply voltage range from 3.0 to 15.0 V
- · CMOS low power dissipation
- High noise immunity
- · Standardized symmetrical output characteristics
- ESD protection:
  - MIL-STD-883, method 3015 exceeds 2000 V
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V (C = 200 pF; R = 0 Ω)
- Complies with JEDEC standard JESD 13-B

### 3. Ordering information

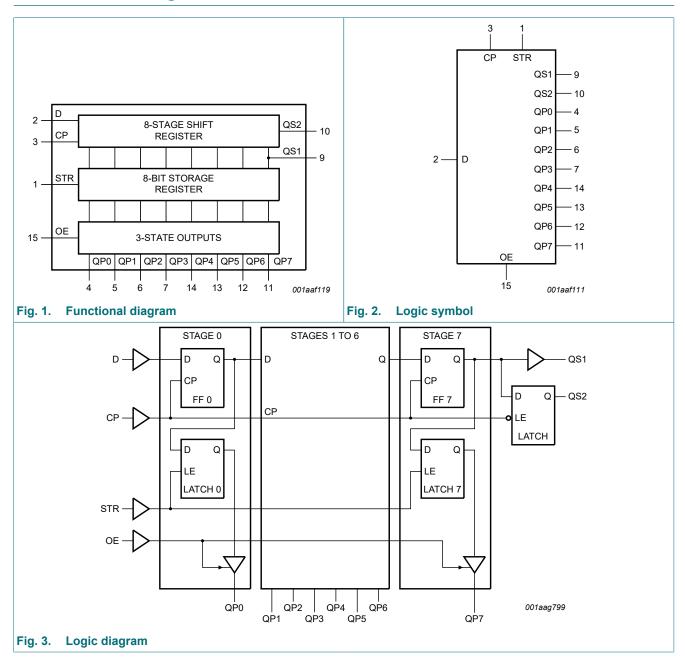
### **Table 1. Ordering information**

All types operate from -40 °C to +125 °C.

Type number	Package	Package								
	Name Description									
HEF4094BT-Q100	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1							
HEF4094BTT-Q100	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1							

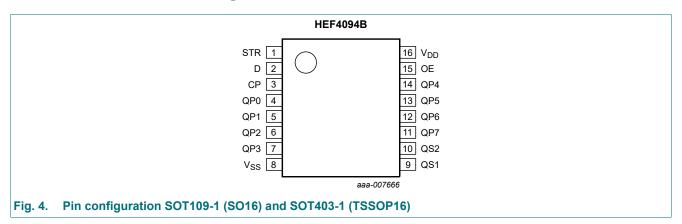


# 4. Functional diagram



## 5. Pinning information

### 5.1. Pinning



### 5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
STR	1	strobe input
D	2	data input
СР	3	clock input
QP0 to QP7	4, 5, 6, 7, 14, 13, 12, 11	parallel output
V <sub>SS</sub>	8	ground supply voltage
QS1	9	serial output
QS2	10	serial output
OE	15	output enable input
$V_{DD}$	16	supply voltage

### 6. Functional description

#### Table 3. Function table

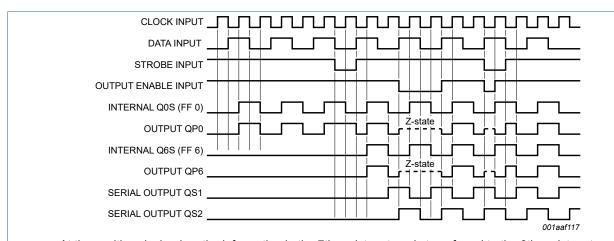
H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = HIGH-impedance OFF-state; NC = no change;

 $\uparrow$  = positive-going transition;  $\downarrow$  = negative-going transition;

Q6S = the data in register stage 6 before the LOW to HIGH clock transition;

Q7S = the data in register stage 7 before the HIGH to LOW clock transition.

Inputs				Parallel o	outputs	Serial out	Serial outputs		
СР	OE	OE STR D		QP0	QPn	QS1	QS2		
$\uparrow$	L	X	Х	Z	Z	Q6S	NC		
$\downarrow$	L	X	X	Z	Z	NC	Q7S		
<b>↑</b>	Н	L	Х	NC	NC	Q6S	NC		
<b>↑</b>	Н	Н	L	L	QPn -1	Q6S	NC		
<b>↑</b>	Н	Н	Н	Н	QPn -1	Q6S	NC		
$\downarrow$	Н	Н	Н	NC	NC	NC	Q7S		



At the positive clock edge, the information in the 7th register stage is transferred to the 8th register stage and the QSn outputs.

Fig. 5. Timing diagram

### 7. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to  $V_{SS} = 0 \text{ V}$  (ground).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DD}$	supply voltage		-0.5	+18	V
I <sub>IK</sub>	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{DD} + 0.5 \text{ V}$	-	±10	mA
VI	input voltage		-0.5	V <sub>DD</sub> + 0.5	V
l <sub>OK</sub>	output clamping current	$V_{O}$ < -0.5 V or $V_{O}$ > $V_{DD}$ + 0.5 V	-	±10	mA
I <sub>I/O</sub>	input/output current		-	±10	mA
I <sub>DD</sub>	supply current		-	50	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
T <sub>amb</sub>	ambient temperature		-40	+125	°C
P <sub>tot</sub>	total power dissipation	[1]	-	500	mW
Р	power dissipation	per output	-	100	mW

<sup>[1]</sup> For SOT109-1 (SO16) package:  $P_{tot}$  derates linearly with 12.4 mW/K above 110 °C. For SOT403-1 (TSSOP16) package:  $P_{tot}$  derates linearly with 8.5 mW/K above 91 °C.

### 8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{DD}$	supply voltage		3	-	15	V
VI	input voltage		0	-	$V_{DD}$	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>DD</sub> = 5 V	-	-	3.75	μs/V
		V <sub>DD</sub> = 10 V	-	-	0.5	µs/V
		V <sub>DD</sub> = 15 V	-	-	0.08	μs/V

### 9. Static characteristics

**Table 6. Static characteristics** 

 $V_{SS} = 0 \ V$ ;  $V_{I} = V_{SS} \ or \ V_{DD}$ ; unless otherwise specified.

Symbol	Parameter	Conditions	$V_{DD}$	T <sub>amb</sub> =	-40 °C	T <sub>amb</sub> =	+25 °C	T <sub>amb</sub> =	+85 °C	T <sub>amb</sub> =	+125 °C	Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
V <sub>IH</sub>	HIGH-level input	I <sub>O</sub>   < 1 μΑ	5 V	3.5	-	3.5	-	3.5	-	3.5	-	V
	voltage		10 V	7.0	-	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	11.0	-	V
V <sub>IL</sub>	LOW-level input	I <sub>O</sub>   < 1 μΑ	5 V	-	1.5	-	1.5	-	1.5	-	1.5	V
	voltage		10 V	-	3.0	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	-	4.0	V
V <sub>OH</sub>	HIGH-level	I <sub>O</sub>   < 1 μΑ	5 V	4.95	-	4.95	-	4.95	-	4.95	-	V
	output voltage		10 V	9.95	-	9.95	-	9.95	-	9.95	-	V
			15 V	14.95	-	14.95	-	14.95	-	14.95	-	V
V <sub>OL</sub>	LOW-level	I <sub>O</sub>   < 1 μΑ	5 V	-	0.05	-	0.05	-	0.05	-	0.05	V
	output voltage		10 V	-	0.05	-	0.05	-	0.05	-	0.05	V
			15 V	-	0.05	-	0.05	-	0.05	-	0.05	V
I <sub>OH</sub>	HIGH-level	V <sub>O</sub> = 2.5 V	5 V	-	-1.7	-	-1.4	-	-1.1	-	-1.1	mA
	output current	V <sub>O</sub> = 4.6 V	5 V	-	-0.64	-	-0.5	-	-0.36	-	-0.36	mA
		V <sub>O</sub> = 9.5 V	10 V	-	-1.6	-	-1.3	-	-0.9	-	-0.9	mA
		V <sub>O</sub> = 13.5 V	15 V	-	-4.2	-	-3.4	-	-2.4	-	-2.4	mA
I <sub>OL</sub>	LOW-level	V <sub>O</sub> = 0.4 V	5 V	0.64	-	0.5	-	0.36	-	0.36	-	mA
	output current	V <sub>O</sub> = 0.5 V	10 V	1.6	-	1.3	-	0.9	-	0.9	-	mA
		V <sub>O</sub> = 1.5 V	15 V	4.2	-	3.4	-	2.4	-	2.4	-	mA
I <sub>OZ</sub>	OFF-state output current	QPn output is HIGH; V <sub>O</sub> = 15 V	15 V	-	0.4	-	0.4	-	12	-	12	μΑ
I <sub>I</sub>	input leakage current		15 V	-	±0.1	-	±0.1	-	±1.0	-	±1.0	μΑ
I <sub>DD</sub>	supply current	all valid input	5 V	-	5	-	5	-	150	-	150	μΑ
		combinations; I <sub>O</sub> = 0 A	10 V	-	10	-	10	-	300	-	300	μΑ
		10 - 0 A	15 V	-	20	-	20	-	600	-	600	μΑ
C <sub>I</sub>	input capacitance			-	-	-	7.5	-	-	-	-	pF

# 10. Dynamic characteristics

**Table 7. Dynamic characteristics** 

 $V_{SS}$  = 0 V;  $T_{amb}$  = 25 °C; for test circuit see Fig. 10; unless otherwise specified.

Symbol	Parameter	Conditions	$V_{DD}$	Extrapolation formula	Min	Тур	Max	Unit
t <sub>PHL</sub>	HIGH to LOW	CP to QS1;	5 V [1]	108 ns + (0.55 ns/pF)C <sub>L</sub>	-	135	270	ns
	propagation delay	see Fig. 6	10 V	54 ns + (0.23 ns/pF)C <sub>L</sub>	-	65	130	ns
			15 V	42 ns + (0.16 ns/pF)C <sub>L</sub>	-	50	100	ns
		CP to QS2;	5 V	78 ns + (0.55 ns/pF)C <sub>L</sub>	-	105	210	ns
		see Fig. 6	10 V	39 ns + (0.23 ns/pF)C <sub>L</sub>	-	50	100	ns
			15 V	32 ns + (0.16 ns/pF)C <sub>L</sub>	-	40	80	ns
		CP to QPn;	5 V	138 ns + (0.55 ns/pF)C <sub>L</sub>	-	165	330	ns
		see Fig. 6	10 V	64 ns + (0.23 ns/pF)C <sub>L</sub>	-	75	150	ns
			15 V	47 ns + (0.16 ns/pF)C <sub>L</sub>	-	55	110	ns
		STR to QPn;	5 V	83 ns + (0.55 ns/pF)C <sub>L</sub>	-	110	220	ns
		see Fig. 7	10 V	39 ns + (0.23 ns/pF)C <sub>L</sub>	-	50	100	ns
			15 V	27 ns + (0.16 ns/pF)C <sub>L</sub>	-	35	70	ns
t <sub>PLH</sub>	LOW to HIGH	CP to QS1;	5 V [1]	78 ns + (0.55 ns/pF)C <sub>L</sub>	-	105	210	ns
	propagation delay,	see Fig. 6	10 V	39 ns + (0.23 ns/pF)C <sub>L</sub>	-	50	100	ns
			15 V	32 ns + (0.16 ns/pF)C <sub>L</sub>	-	40	80	ns
		CP to QS2;	5 V	78 ns + (0.55 ns/pF)C <sub>L</sub>	-	105	210	ns
		see Fig. 6	10 V	39 ns + (0.23 ns/pF)C <sub>L</sub>	-	50	100	ns
			15 V	32 ns + (0.16 ns/pF)C <sub>L</sub>	-	40	80	ns
		CP to QPn;	5 V	123 ns + (0.55 ns/pF)C <sub>L</sub>	-	150	300	ns
		see Fig. 6	10 V	59 ns + (0.23 ns/pF)C <sub>L</sub>	-	70	140	ns
			15 V	47 ns + (0.16 ns/pF)C <sub>L</sub>	-	55	110	ns
		STR to QPn;	5 V	73 ns + (0.55 ns/pF)C <sub>L</sub>	-	100	200	ns
		see Fig. 7	10 V	34 ns + (0.23 ns/pF)C <sub>L</sub>	-	45	90	ns
			15 V	27 ns + (0.16 ns/pF)C <sub>L</sub>	-	35	70	ns
t <sub>t</sub>	transition time		5 V [1]	10 ns + (1.00 ns/pF)C <sub>L</sub>	-	60	120	ns
			10 V	9 ns + (0.42 ns/pF)C <sub>L</sub>	-	30	60	ns
			15 V	6 ns + (0.28 ns/pF)C <sub>L</sub>	-	20	40	ns
t <sub>PZH</sub>	OFF-state to HIGH	OE to QPn;	5 V		-	40	80	ns
	propagation delay	see Fig. 8	10 V		-	25	50	ns
			15 V		-	20	40	ns
t <sub>PZL</sub>	OFF-state to LOW	OE to QPn;	5 V		-	40	80	ns
	propagation delay	see Fig. 8	10 V		-	25	50	ns
			15 V		-	20	40	ns
t <sub>PHZ</sub>	HIGH to OFF-state	OE to QPn;	5 V		-	75	150	ns
	propagation delay	see Fig. 8	10 V		-	40	80	ns
			15 V		-	30	60	ns
t <sub>PLZ</sub>	LOW to OFF-state	OE to QPn;	5 V		-	80	160	ns
	propagation delay	see Fig. 8	10 V		-	40	80	ns
			15 V		-	30	60	ns

Symbol	Parameter	Conditions	$V_{DD}$	Extrapolation formula	Min	Тур	Max	Unit
t <sub>su</sub>	set-up time	D to CP;	5 V		60	30	-	ns
		see Fig. 9	10 V		20	10	-	ns
			15 V		15	5	-	ns
t <sub>h</sub>	hold time	D to CP;	5 V		+5	-15	-	ns
		see Fig. 9	10 V		20	5	-	ns
			15 V		20	5	-	ns
t <sub>W</sub>	pulse width	minimum LOW	5 V		60	30	-	ns
		clock pulse; see Fig. 6	10 V		30	15	-	ns
		<u>1 ig. 0</u>	15 V		24	12	-	ns
		minimum HIGH	5 V		40	20	-	ns
		strobe pulse; see <u>Fig. 7</u>	10 V		30	15	-	ns
		366 <u>1 lg. 7</u>	15 V		24	12	-	ns
f <sub>max</sub>	maximum frequency	see Fig. 6	5 V		5	10	-	MHz
			10 V		11	22	-	MHz
			15 V		14	28	-	MHz

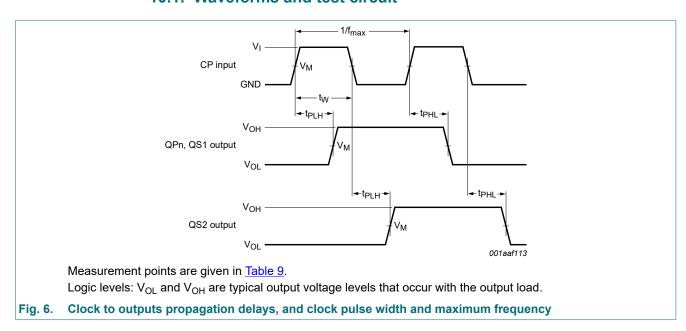
[1] The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown (C<sub>L</sub> in pF).

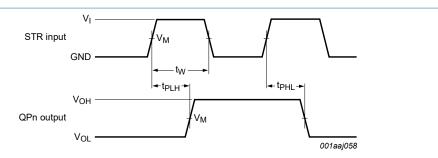
### **Table 8. Dynamic power dissipation**

 $V_{SS} = 0 \ V; \ t_r = t_f \le 20 \ ns; \ T_{amb} = 25 \ ^{\circ}C.$ 

Symbol	Parameter	$V_{DD}$	Typical formula for P <sub>D</sub> (μW)	where:
$P_D$	dynamic power	5 V	1 (0 1/ 00	f <sub>i</sub> = input frequency in MHz,
	dissipation	10 V	$P_D = 9700 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$	f <sub>o</sub> = output frequency in MHz, C <sub>L</sub> = output load capacitance in pF,
		15 V	$P_D = 26000 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$	$V_{DD}$ = supply voltage in V, $\Sigma(f_0 \times C_L)$ = sum of the outputs.

### 10.1. Waveforms and test circuit

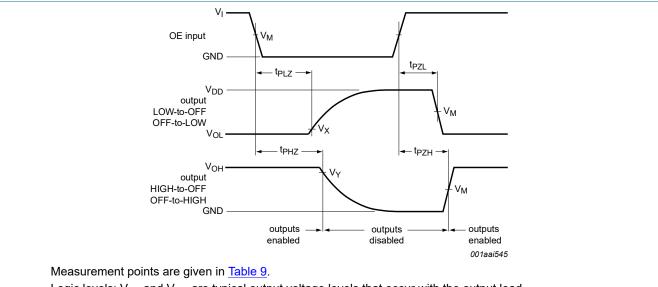




Measurement points are given in Table 9.

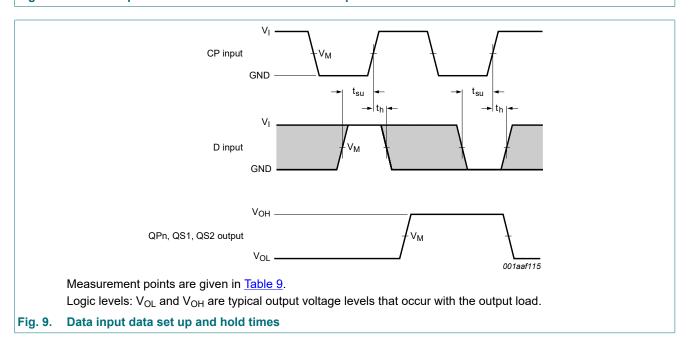
Logic levels: V<sub>OL</sub> and V<sub>OH</sub> are typical output voltage levels that occur with the output load.

Fig. 7. Strobe to output propagation delays, and strobe pulse width, set up and hold times



Logic levels:  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Fig. 8. 3-state output enable and disable times for OE input



**Table 9. Measurement points** 

Supply voltage	Input	Output					
V <sub>DD</sub>	V <sub>M</sub>	$V_{M}$ $V_{X}$ $V_{Y}$					
5 V to 15 V	0.5V <sub>DD</sub>	0.5V <sub>DD</sub>	0.1V <sub>DD</sub>	0.9V <sub>DD</sub>			

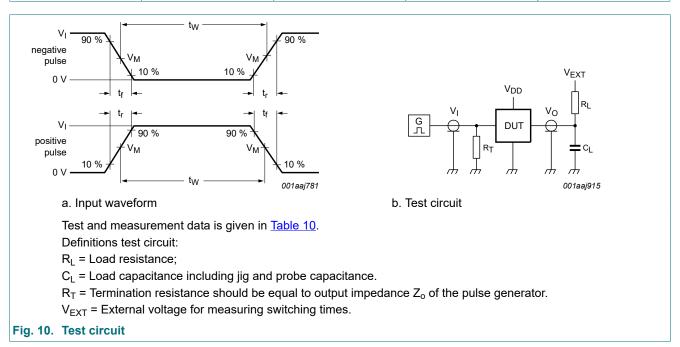


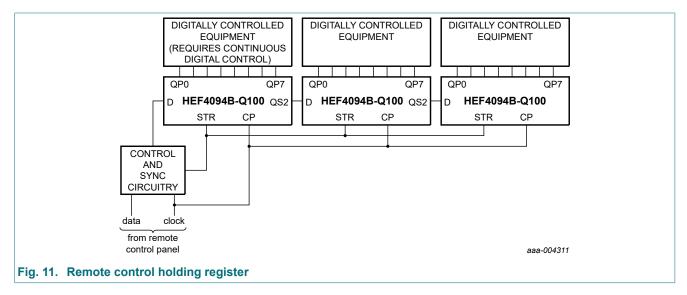
Table 10. Test data

Supply voltage	Input		V <sub>EXT</sub>		Load		
$V_{DD}$	V <sub>I</sub> t <sub>r</sub> , t <sub>f</sub>		t <sub>PHL</sub> , t <sub>PLH</sub>	t <sub>PHZ</sub> , t <sub>PZH</sub>	t <sub>PLZ</sub> , t <sub>PZL</sub> C <sub>L</sub>		R <sub>L</sub>
5 V to 15 V	$V_{SS}$ or $V_{DD}$	≤ 20 ns	open V <sub>SS</sub>		$V_{DD}$	50 pF	1 kΩ

# 11. Application information

Some examples of applications for the HEF4094B-Q100 are:

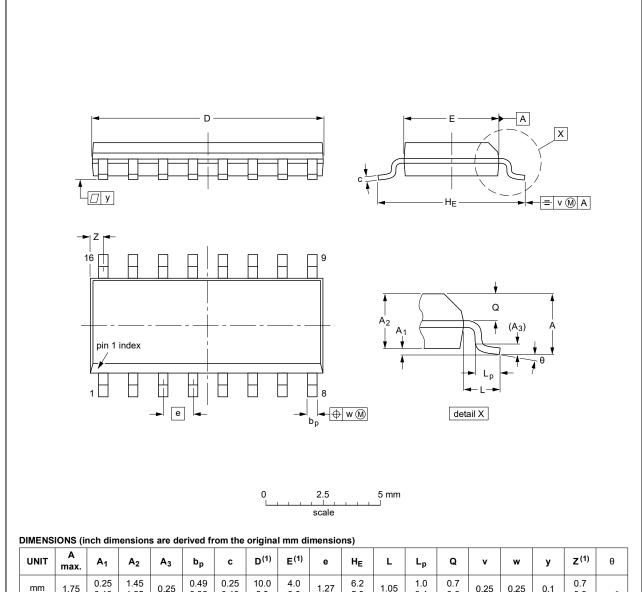
- · Serial-to-parallel data conversion
- Remote control holding register



## 12. Package outline

### SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



UNIT	A max.	<b>A</b> <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

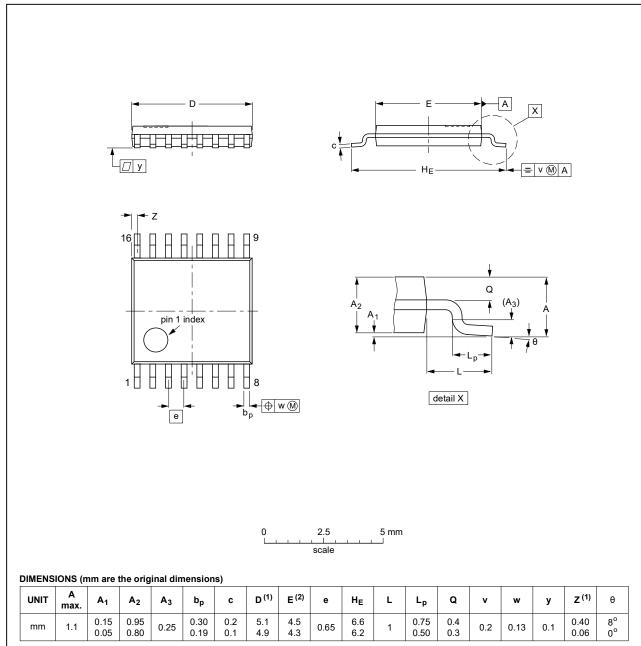
OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT109-1	076E07	MS-012				<del>99-12-27</del> 03-02-19

Fig. 12. Package outline SOT109-1 (SO16)

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TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT403-1		MO-153				<del>99-12-27</del> 03-02-18

Fig. 13. Package outline SOT403-1 (TSSOP16)

### 13. Abbreviations

#### **Table 11. Abbreviations**

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MIL	Military
MM	Machine Model

# 14. Revision history

### Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
HEF4094B_Q100 v.5	20210708	Product data sheet	-	HEF4094B_Q100 v.4	
Modifications:	<ul> <li>Section 1 and Section 2 updated.</li> <li>Section 7: Derating values for P<sub>tot</sub> total power dissipation updated.</li> </ul>				
HEF4094B_Q100 v.4	20181114	Product data sheet	-	HEF4094B_Q100 v.3	
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Fig. 5 corrected.</li> </ul>				
HEF4094B_Q100 v.3	20130704	Product data sheet	-	HEF4094B_Q100 v.2	
Modifications:	• Fig. 3 corrected (errata).				
HEF4094B_Q100 v.2	20130606	Product data sheet	-	HEF4094B_Q100 v.1	
Modifications:	added type number HEF4094BTT-Q100.				
HEF4094B_Q100 v.1	20120807	Product data sheet	-	-	

### 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <a href="https://www.nexperia.com">https://www.nexperia.com</a>.

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